

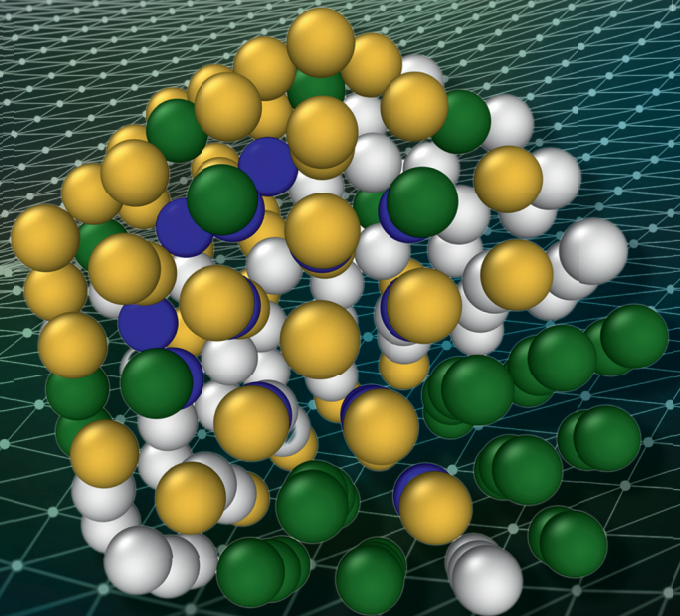
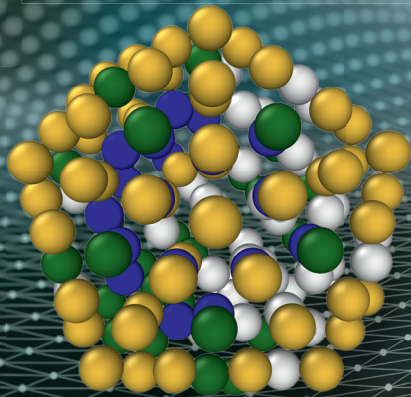
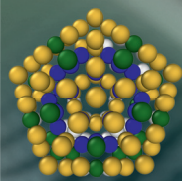
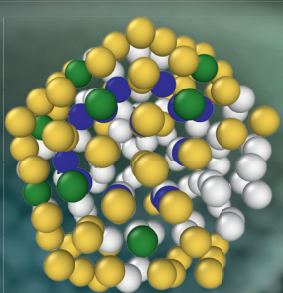


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FOCUS ISSUE

**Advanced Atomistic Algorithms
in Materials Science**



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